



Final Product Change Notification

201905018F01

Issue Date: 05-Jun-2019
Effective Date: 03-Sep-2019

Here's your personalized quality information concerning products Digi-Key purchased from NXP. For detailed information we invite you to view this notification online



QUALITY

This notice is NXP Company Proprietary.

Change Category

- | | | | | |
|--|---|--|---|---|
| <input type="checkbox"/> Wafer Fab Process | <input type="checkbox"/> Assembly Process | <input type="checkbox"/> Product Marking | <input checked="" type="checkbox"/> Test Location | <input type="checkbox"/> Design |
| <input type="checkbox"/> Wafer Fab Materials | <input type="checkbox"/> Assembly Materials | <input type="checkbox"/> Mechanical Specification | <input type="checkbox"/> Test Process | <input type="checkbox"/> Errata |
| <input type="checkbox"/> Wafer Fab Location | <input type="checkbox"/> Assembly Location | <input type="checkbox"/> Packing/Shipping/Labeling | <input type="checkbox"/> Test Equipment | <input type="checkbox"/> Electrical spec./Test coverage |
| <input type="checkbox"/> Firmware | <input type="checkbox"/> Other | | | |

S9S08RN60 Final Test Site Expansion from NXP-ATTJ to KESM Tianjin

Description of Change

NXP Semiconductors announces the Final Test site expansion for the S9S08RN60 products associated with this notification from NXP-ATTJ, Tianjin, China Final Test site to the KESM Tianjin, China Final Test site.

Final Test site expansion was successfully qualified adhering to NXP specifications. Corresponding ZVEI Delta Qualification Matrix ID: SEM-TF-01

Please see the attached file(s) for additional details.

Reason for Change

Qualification of KESM Tianjin, China is required for manufacturing flexibility and customer supply assurance.

Identification of Affected Products

Product identification does not change

Product Availability

Sample Information

Not applicable

Production

Planned first shipment 15-Oct-2019

Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

Disposition of Old Products

Test Site Expansion, no depletion of inventory required. NXP will reserve the right to ship from any location based on market demand situation.

Timing and Logistics

In compliance with JEDEC J-STD-046, your acknowledgement of this change is expected by 05-Jul-2019.

Contact and Support

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

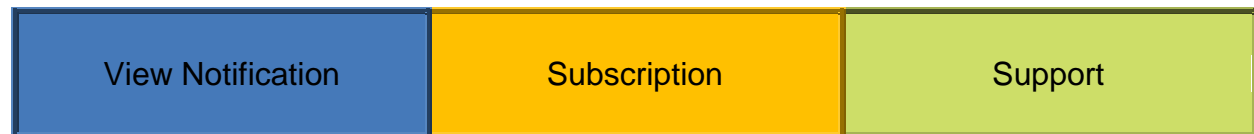
NXP Quality Management Team.

About NXP Semiconductors

NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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NXP Semiconductors

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Changed Orderable

<u>Part#</u>	<u>Changed Part 12NC</u>
S9S08RNA60W1VLHR	935315392528
S9S08RNA32W1VLC	935315499557
S9S08RN48W1CLF	935320364557
S9S08RN48W1VLF	935325813557
S9S08RN32W1VLCR	935320637528
S9S08RNA32W1MLCR	935324744528
S9S08RN60W1VLH	935320434557

